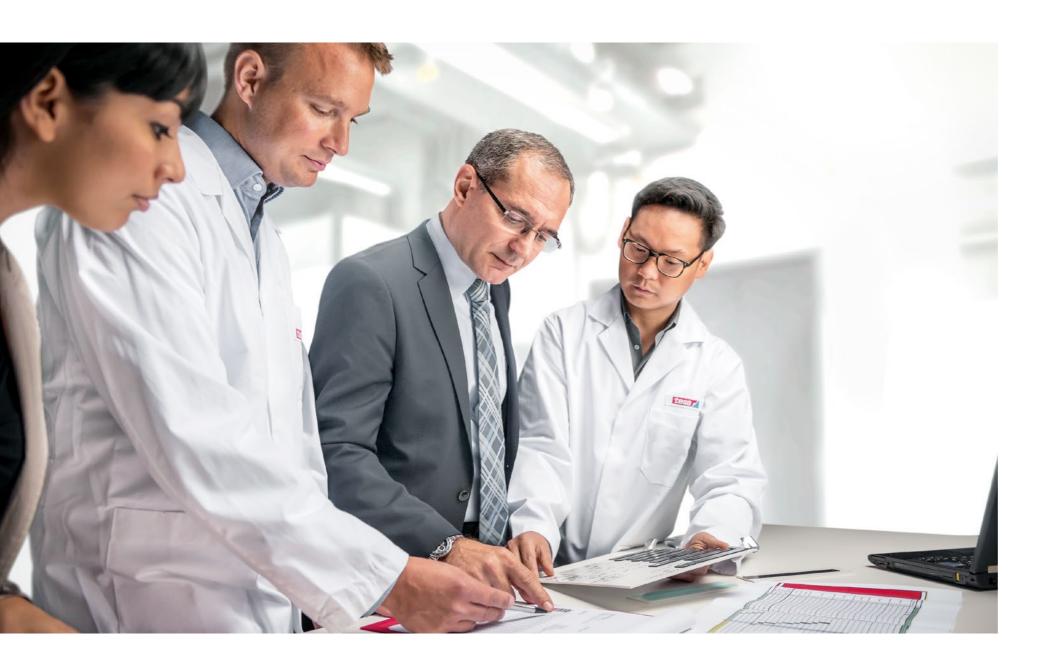


Enabling the future of the electronics industry 2022

About us



Qualified experience and individual support

As a leading adhesive manufacturer in the electronics industry, we offer a wide range of customized adhesive tapes for smartphones, tablets, and other electronic devices. We work continuously to develop new products to better serve you and your customers in this fast-moving and innovative industry.

You and your suppliers are our priority. Our team of experts – from sales offices, R&D centers, and manufacturing facilities – is available globally to support our customers locally. Particularly, our Customer Solution Center with its technical experts is there to offer you the individual support you need. Our state-of-the-art facility with extensive equipment is at your disposal to find the adhesive solution for your needs.

Contents

	Pag
Introduction	
Your complete partner	4
Tapes for your success	5
Our commitment to sustainability	6-7
Mounting solutions	
Double-sided film tapes	8
High performance profile	8-9
Specialized performance profile	10 – 11
Well-balanced performance profile	12 – 13
Impact-resistant foam tapes	14
Acrylic foam tapes	14 – 15
PE foam tapes	16 – 17
Special foam tapes	18-19
Bond & Detach®	20
Stretch-release tapes	20-21
Structural bonding solutions	22
Heat-activated films	22-23
Low-temperature reactive films	22-23
Functional solutions	
Electrically conductive solutions	24
Double-sided electrically conductive tapes	24-25
Single-sided electrically conductive tapes	26-27
Single-sided electrically conductive foam tapes	28-29
Thermal management tapes	30
Thermal management tapes	30-31
Covering tapes	32
Covering tapes	32-33
Display lamination solutions	
Optically clear adhesive tapes	34
Optically clear adhesive tapes	34-37
Global presence – Contacts	38

2 About us Contents 3

Your complete partner

Solutions that go beyond tape

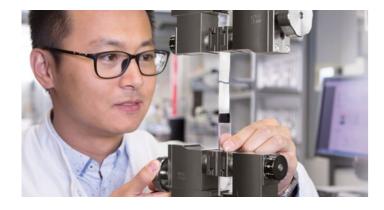
Every project comes with new and individual challenges. We overcome these challenges by partnering with you to create unique and specialized products that meet and exceed your customers' expectations. Our capability goes beyond tape, as we also offer a comprehensive technical product package.



Our labs and technical experts

With our extensive experience in adhesive technology, we have developed a large portfolio of adhesive products for electronics applications.

Our technical experts will support you throughout your entire product development process and help you find the optimal solution for your requirements.



On-site support

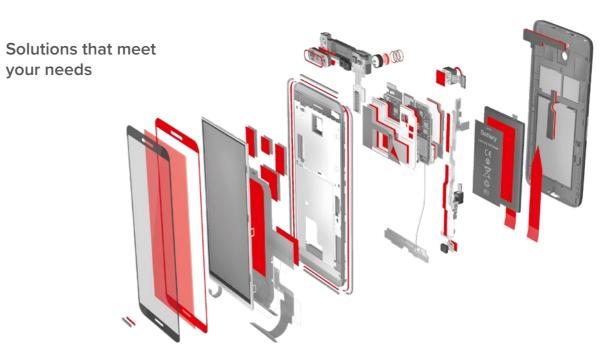
We provide individual project support backed up by application engineers and research and development resources. Our technical experts in our Customer Solution Center offer on-site support and evaluation of your individual application under laboratory conditions.



Our local experts and engineers are just a phone call away to support you with:

Process-simulation studies Assistance at your manufacturing site State-of-the-art testing equipment Tests under a wide range of environmental conditions Customized tests with customer substrates

Tapes for your success



Tape solutions for smartphones

Our products have a proven track record in multiple applications and different devices over the last 20 years in the electronics industry. In this brochure we present an assortment of the most significant tapes from our portfolio. We divide them into the following categories:

- Mounting Solutions
- Functional Solutions
- Display Lamination Solutions

As each project has specific requirements, we offer tailored solutions to each application.

Our mission is to provide you with the best solution. Please contact our local representative to discuss this in detail.

Features of our tapes



Impact resistance











resistance

Bonding performance

Conformability

Flectrical

conductivity

Residue-free

blocking

Anti-repulsion

Moisture Outgassing

... and many more

Contact us and benefit from a strong partnership.

4 Introduction – Your complete partner

Our commitment to sustainability

Just like us, many of our customers are committed to achieving greater sustainability. We support them by enabling them to make technological progress and actively contribute to sustainability through our products.



"Electronic equipment is complex. Intelligent solutions are necessary in order to make it more sustainable – for instance, in order to improve its recyclability. At tesa, we are aiming to play a leading role in this process. Our "Bond & Detach®" products demonstrate what that means in practice. They make it possible to easily remove the individual components of a smartphone – either for repair purposes or at the end of the phone's life – and to recycle them separately. At the same time, we would like to help extend the life of electronic equipment through our products so that items don't have to be disposed of so quickly."

Carsten Meyer-Rackwitz

Corporate Vice President Business Unit Electronics



Reducing a product's carbon footprint while maintaining the same level of quality is a core product development issue for us. In the future, we intend to use an increased volume of raw materials that are more environmentally and climate friendly than conventional raw materials. Here, we evaluate the use of different raw materials. In particular, the use of recycled and bio-based raw materials is currently a key concern for us.

For example, with our new bio-based PET tapes, which use 50% recycled materials for the PET backing and whose adhesive consists of more than 70% bio-based carbon content.

At the same time, we avoid scarce raw materials or raw materials whose extraction places an excessive burden on the environment. We are also looking to make further reductions in our use of solvents during the production process.



Smart products for sustainability

We aim to help our customers work toward a circular economy. Our tesa® Bond & Detach products, for example, assist with this process. If modern smartphones are no longer needed or are broken, it is generally difficult to take them apart. Our tesa® Bond & Detach products make it possible to

attach components such as batteries and many other parts so that they remain securely in place until the product life is over. They can then be removed without any difficulty and without leaving any residue. Electronic parts can thus be replaced, properly disposed of, or recycled.

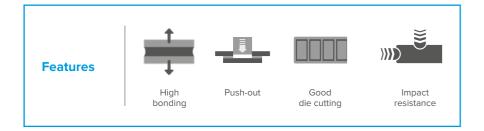
6 Introduction – Our commitment to sustainability Introduction – Our commitment to sustainability 7



High performance profile

Our high performance profile tapes are the spearhead of our film tapes assortment. All series in this category are expressed in peel adhesion, push-out and shear resistance,

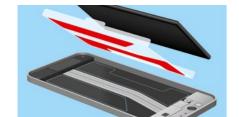
and high impact resistance. These series are therefore used for demanding applications like lens and battery mounting. characterized by superior bonding performance, which is
The PET backings used in these series are very well suited to being die-cut.



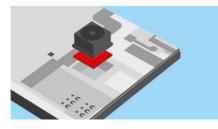
Typical applications







Battery mounting



Component mounting

Assortment overview

		tesa® 613xx	tesa® 618xx	tesa® 6896x
De	sign			
Col	lor	Transparent, black	Black	Transparent
Adl	hesive	Tackified acrylic	Modified acrylic	Specialty
Bad	cking	PET	PET	PET
	ecial tures	Push-out resistance, strong bonding	Push-out resistance, impact resistance, LSE performance	Strong bonding, easy activation, LSE performance
	30 μm			O 68960
	50 μm	o 61305 ● 61350		0 68962
	100 μm	o 61360 ● 61365	● 61865	0 68964
CELICATION	125 μm	o 61370 ● 61375		
	150 μm	o 61380 ● 61385	● 61885	
	200 μm	o 61390 ● 61395	● 61895	
	230 μm	• 61345	● 61845	
	250 μm	• 61325	● 61825	
	300 μm	● 61315	● 61815	
בע	Reference product	• 61365 • 61360	● 61865	o 68964
riognet periorinance	Peel adhesion [N/cm; SUS initial/ ultimate]	11.9/16.5	11.0/12.0	17.0/17.5
2	Push-out [N]	250	240	255
	DuPont [J; xy/z]	0.5/0.2	0.7/0.3	0.7/0.6

O Transparent ● Black

8 Mounting solutions – Double-sided film tapes Mounting solutions – Double-sided film tapes 9



Specialized performance profile

With this assortment, we created double-sided mounting tapes with unique adhesives focusing on the special requirements of certain applications in the electronics industry. Each series within this assortment focuses on a specific property needed in the market. In this section, you will find a selection of specialized film tapes. Our capabilities go beyond what is available here. Please contact our local representatives to discuss this further.





repulsion





designs



LSE

performance



resistance









Impact resistance

Temperature resistance

Typical applications







Our specialized film tape solutions are suitable for applications with a high demand for a certain property like anti-repulsion, differential bonding performance, chemical resistance, reworkability, or light blocking. These tapes are suitable for a wide range of applications, from mounting (e.g., FPC, antenna, keypad, sensor) to processing and packaging applications.

Assortment overview

		tesa® 6693x	tesa® 615xx	tesa® 612xx/6128x	tesa® 6881x	tesa® 885x	tesa® 6887x K
Des	sign					Course to set the course	
Col	lor	Transparent	Transparent	Black	Black	Translucent	Transparent
Adl	hesive	Tackified acrylic	Silicone/acrylic	Specialty	Tackified acrylic	Tackified acrylic	Bio-based acrylic
Bad	cking	PET	PET	PET	PET	Nonwoven	PCR PET
-	ecial tures	Repulsion resistance, easy activation	Differential design for silicone substrates LSE performance	Chemical resistance, impact resistance	LSE performance, high tack, impact resistance	Temperature resistance	Bio-based PET solution, high bonding
	30 μm	0 66930	0 61526			O 8851	0 68873
ess	50 μm	0 66932	0 61532	• 61250/61282		O 8853 O 8857	0 68875
Inickness	100 μm	0 66934	0 61528	• 61210/61284	● 68814	0 8854	0 68877
-	140 μm		0 61529				
	150 μm			• 61215/61286			
	200 μm		o 61520	• 61220/61287	● 68817		
	250 μm			◆ 61225/61288			
Product performance	Reference product	0 66934	0 61528	● 61210	● 68814	0 8854	O 68877
	Peel adhesion [N/cm; SUS initial/ ultimate]	10.7/11.6	Si: 4.0/4.4 Ac: 10.7/12.6	12.4/13.2	13.5/14.0	8.3/9.5	12.3/13.7
Pro	Push-out [N]	143	Upon request	260	130	Upon request	Upon request
	DuPont [J; xy/z]	0.7/0.2	Upon request	1.1/0.7	0.9/0.4	Upon request	Upon request

O Transparent • Black O Translucent

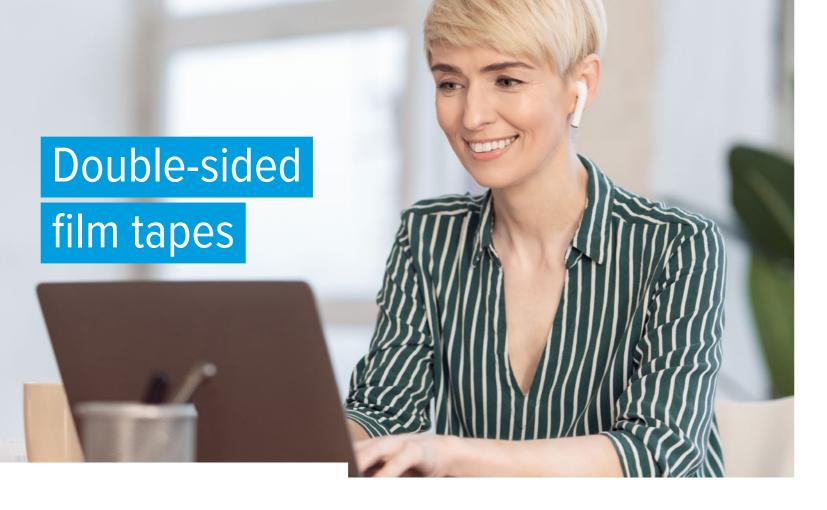
Our sustainable solutions

We are continuously increasing our range of sustainable products to help our customers achieve their own sustainability goals. We are willing to offer products that have the lowest possible impact on the environment throughout their life cycle. The use of recycled and bio-based raw materials plays a particularly important role here. In our product development, we focus on the design and integration of various sustainable building blocks in order to provide our customers with the greatest possible flexibility in the selection of products. Reach out to us, learn more about this exciting development, and become part of it!



10 Mounting solutions – Double-sided film tapes

Mounting solutions – Double-sided film tapes



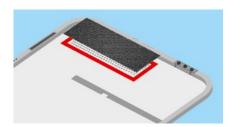
Well-balanced performance profile

tesa® balanced-performance film tapes are a proven solution for mounting and lamination applications in the electronics industry. The balanced adhesive provides very good tack and bonding performance for many general applications. The PET backing enables easy handling of the tape

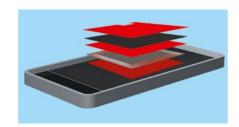
during converting and manufacturing processes. With thicknesses from 5 μm to 250 μm , this assortment offers you a broad range and excellent flexibility.



Typical applications







This assortment is widely used in the electronics industry for versatile mounting and lamination applications as well as for cushioning and gasket material bonding.

Assortment overview

		tesa® 49xx	tesa® 519xx	
De	sign			
Со	lor	Transparent	Black	
Ad	hesive	Tackified acrylic	Tackified acrylic	
Bad	cking	PET	PET	
	5 μm	0 4912		
	30 μm	O 4983	● 51983	
	50 μm	o 4972	● 51972	
	80 μm	O 4980	● 51980	
S	100 μm	O 4982	● 51982	
Thickness	125 μm	O 4928	● 51928	
Ė	140 μm	O 4942		
	160 μm	o 4967	● 51967	
	200 μm	O 4965	● 51965	
	250 μm	O 4926	● 51926	
ıce	Reference product	O 4982	● 51982	
Product performance	Peel adhesion [N/cm; SUS initial/ ultimate]	11.0/11.7	11.0/11.7	
Pro	Push-out [N]	230	230	
	DuPont [J; xy/z]	0.5/0.2	0.5/0.2	

O Transparent • Black

Can't find the right solution?

We have more options available in our portfolio, and by partnering with you we can create unique and specialized products that meet your individual demands. Simply write to us or contact your local representative: electronics@tesa.com



12 Mounting solutions – Double-sided film tapes

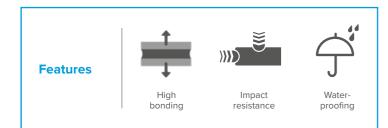
Mounting solutions – Double-sided film tapes 13



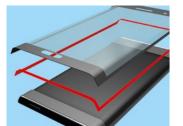
For applications with extreme requirements

Our acrylic foam tape assortment is especially designed for demanding applications in the electronics industry and is distinguished by its very special bonding capabilities. The high bonding performance is possible due to the tape's viscoelasticity: elastic and viscous characteristics provide inner strength and relax mechanical stresses. The use of

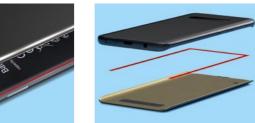
highly innovative technologies and special acrylic adhesive systems together with the viscoelastic nature of acrylic foams create multiple benefits like impact resistance, high bonding strength, and waterproofing for electronic devices for the entire life cycle of the product.



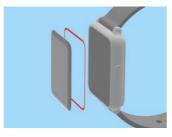
Typical applications







Display bottom



Mounting in wearables devices

Assortment overview

		tesa® 754 xx/ 756 xx	tesa® 759xx	tesa® 758xx	tesa® 757xx	tesa® 7017 x
Desig	gn	THE REAL PROPERTY.	Control States		1.50 P. Starten	- American Company
Colo	r	Black	Black	Black	Black, white	Black
Adhe	esive	Modified acrylic	Acrylic	Acrylic	Modified acrylic	Modified acrylic
Back	ing	-	PET	-	PET	PET
Spec featu		Excellent bonding, conformability	Chemical resistance, reworkability	Chemical resistance, excellent shock resistance	Good wetting, reworkability	Anti-stretching, easy activation
į	50 μm	● 75405		● 75805		
1	100 μm	● 75410		● 75810	● 75710	
1	150 μm	● 75415		● 75815	● 75715 ○ 75742	
sel	200 μm	● 75620	● 75920	● 75820	● 75720 ○ 75743	● 70172
Thickness	250 μm	● 75625	● 75925		● 75725 ○ 75745	
3	300 μm	● 75630	● 75930		● 75730	● 70174
3	350 μm	● 75635				
4	400 μm	● 75640				
4	450 μm	● 75645				
	Reference product	● 75620	● 75920	● 75820	● 75720	● 70172
erformal	Peel adhesion [N/cm; SUS initial/	11.2/17.0	10.2/11.3	8.5/9.6	12.3/13.5	14.0/15.0
Produc	Push-out [N]	220	160	140	205	210
-	DuPont [J; xy/z]	1.3/1.0	1.2/0.9	1.5/1.0	0.9/0.8	1.4/1.0
	Remov- ability*	•	•••	•	•••	•••

 $^{^{\}ast}$ Assessment is done only in relation to other products of this assortment

O White ● Black

Your partner for co-development

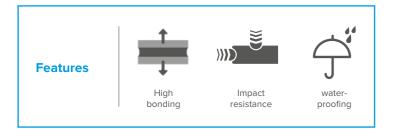
We have more options available in our portfolio, and by partnering with you we can create unique and specialized products that meet your individual demands Simply write to us or contact your local representative: electronics@tesa.com





For challenging applications

PE foam tapes have long proven their value to the electronics industry. Certain properties such as impact resistance, bonding strength, and waterproofing are offered by all series in our PE foam range. In this section we present a selection of our PE foam solutions focusing on different series' specific performance features. We believe these functionalities are strongly needed in the market for certain applications. If you require more information than what we have provided here, please contact your local representative.



Typical applications

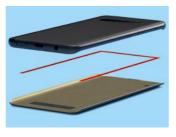


Lens mounting



Back cover mounting





Camera lens mounting Display bottom mounting

Assortment overview

		tesa® 666xx	tesa® 668xx	tesa® 6262x	tesa® 6264x	tesa® 6698x	tesa® 628xx
Des	sign		1553 1788				
Col	lor	Black	Black, white	Black	Black	Black	Black
Adl	hesive	Tackified acrylic	Modified acrylic	Tackified acrylic	Tackified acrylic	Acrylic	Tackified acrylic
Bad	cking	PE foam	PE foam	PE foam	PE foam with PET reinforcement	PE foam	PE foam
	ecial tures	Best shear resistance, repulsion resistance	Best impact resistance, repulsion resistance	Best bonding, conformability	Good die cuttability, balanced property profile	Chemical resistance, repulsion resistance	Best repulsion resistance
	150 μm		● 66822				
	200 μm	● 66624	● 66824	• 62624		● 66984	• 62864
000	250 μm	● 66625	● 66825 ● 66865	• 62625	• 62645	● 66985	● 62865
Thickness	300 μm	● 66626	● 66826 ● 66866	● 62626	● 62646	● 66986	● 62866
	350 μm	● 66627	● 66829				● 62867
	400 μm		● 66828				
	Reference product	● 66626	● 66826	● 62626	● 62646	● 66986	● 62866
	Peel adhesion SUS	10.0/12.2	12.5/14.5	13.0/16.0	10.0/13.5	7.8/8.5	7.6/11.5
בוסמקר לפווסווופווכם	[N/cm; initial/ ultimate] PC	11.0/14.3	12.5/16.0	15.0/16.0	11.0/15.5	9.2/15.5	4.8/10.9
)	Push-out [N]	248	252	180	180	252	226
2	DuPont [J; xy/z]	0.85/0.74	0.88/0.77	0.48/0.42	0.45/0.41	0.81/0.88	0.72/0.70
	Compression force at 25% [kPa]	785	515	200	315	790	835
	Rework- ability*	••••	••••	•	••	••••	••••
	Anti-repulsion*	••••	••••	•	•	••••	• • • •

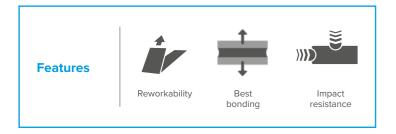
^{*} Assessment is done only in relation to other products of this assortment

Black

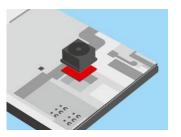


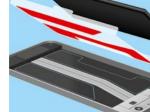
For improved reworkability

These products focus on excellent reworkability, which is provided by specific, tailor-made adhesive designs. Additionally, this series, like the other foam assortments, offers excellent impact resistance and bonding performance.



Typical applications









Component mounting Battery wrapping

Battery mounting

Back cover mounting

Assortment overview

		tesa® 761xx	tesa® 471x	tesa® 473x
Des	sign	THE REAL PROPERTY.	The second of the second second	
Col	or	Black	Translucent white	Translucent white
Adl	nesive	Synthetic rubber	Specialty	Structured specialty
Bad	king	PET	PU	-
Rer	noval process	Fast and residue-free removal at elevated temperatures	Splittable design, removable by solvents	Structured surface, residue-free removable by solvents
	ecial tures	Quick bonding, LSE performance	× Removable by solvents	Residue-free removal, removable by solvents
	50 μm	● 76105	O 4715	o 4735
	80 μm	● 76108	o 4718	o 4738
	100 μm	• 76110	o 4710	
Thickness	150 μm	• 76115		
Thic	200 μm	● 76120		
	250 μm	● 76125		
	300 μm	● 76130		
lce	Reference product	● 76108	o 4718	o 4738
Product performance	Peel adhesion [N/cm; SUS initial/ ultimate]	7.0/7.0	7.0	6.5
Pro	Push-out [N]	230	230	230
	DuPont [J; xy/z]	0.7/0.6	0.7/0.6	0.7/0.8

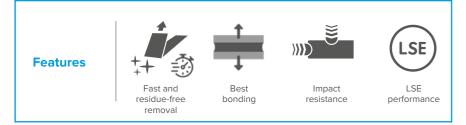
O Translucent O White ● Black



Stretch-release tapes for residue-free removability

Our Bond & Detach® solutions have revolutionized the removability of adhesives. This tape enables the permanent mounting of components with the option of removing them without residues. Bond & Detach® uses a unique adhesive technology for demanding bonding applications, that provides the option of being removed residue-free by stretching.

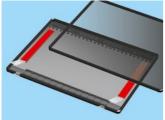
The patented technology was developed by tesa and offers the possibility of simple and secure debonding during the entire product life cycle – from production to end of life. It can also be used for temporary fixation during production processes or transportation. In addition, the whole assortment provides good impact resistance and bonding strength, even on LSE substrates.



Typical applications



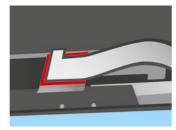
Battery mounting in mobile devices



Mounting of high-value or critical



Removable mounting of devices or



 $\label{temporary fixation of components} \label{temporary fixation of components}$

Assortment overview

	tesa® 704xx/703xx/706xx	tesa® 672xx	tesa® 648xx	tesa® 705xx
Design				
Color	White, transparent, black	Translucent white	White	White
Adhesive	Synthetic rubber	Synthetic rubber	Synthetic rubber	Synthetic rubber
Backing	-	PU	Specialty	Specialty
Special features	Best bonding, light blocking	Very good impact resistance	Excellent impact and tear resistance	Anti-repulsion and shear resistance at elevated temperatures
80 μm		0 67208		
100 μm	○ 70410 ● 70610	0 67210	0 64810	
150 μm	 70315 70415 70615	o 67215	o 64815 o 64816	
200 μm	o 70420 o 70620		0 64820	
250 μm	o 70425 ● 70625		0 64825	070525
300 μm	○ 70430 ● 70630		0 64830	
% 350 μm	o 70435 ● 70635			
	o 70440 ● 70640			
500 μm	 70350 70650			0 70550
650 μm	○ 70465 ● 70665			
800 μm	o 70480 ● 70680	X		
1000 μm	o 70499 ● 70699			
1300 μm	● 70697			
Reference product	○ 70415 ○ 70315 ● 70615	o 67215	0 64815	0 70525*
Peel SUS	13.0/13.0	9.0/9.0	11.0/11.0	13.0/13.0
adhesion E [N/cm; PE initial/	7.0/7.0	6.0/6.0	8.0/8.0	9.0/9.0
Peel SUS adhesion [N/cm; PE initial/ ulti- Black mate] battery pouch DuPont	8.0/8.0	7.0/7.0	8.0/8.0	Upon request
DuPont [J; xy/z]	0.7/0.3	1.0/0.7	1.1/0.8	1.0/0.7
Tumbler [cycles]	Upon request	400	>500	Upon request
Removing force [N/cm]	4.0	5.0	4.0	6.0

^{*} Deviating thickness

20 Mounting solutions – Bond & Detach® 21

O Transparent O Translucent O White ● Black



The best reliability for the toughest demands

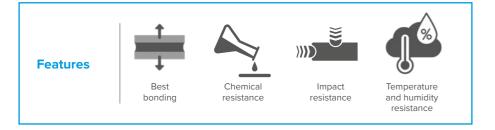
tesa® structural bonding solutions provide high structural bonding performance to a wide variety of substrates. They withstand the harshest conditions by combining outstanding chemical and aging resistance. The processing of these adhesive systems is simplified due to excellent die cuttability, immediate handling stability after activation, and low oozing.

Heat-activated films

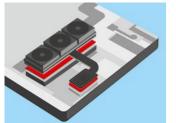
tesa® HAF and tesa® XPU are thermosetting adhesive systems. An irreversible cross-linking reaction is initiated by heat and pressure starting at temperatures above 110°C, resulting in extremely strong bonds.

Low-temperature reactive films

Our low-temperature reactive films tesa® LTR and tesa® LTC have been designed for activation at moderate temperatures. The cross-linking starts at a bond-line temperature above 75°C.



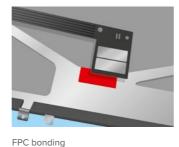
Typical applications



Component mounting

Lens and back cover mounting





Soft goods and accessories

Assortment overview

		Heat-activated films		Low-temperature reactive films		
		tesa® HAF	tesa® XPU	tesa® LTR	tesa® LTC	
esign						
Color		Black, amber	Black, translucent	Black, white, translucent	Black	
dhesive		Nitrile rubber/phenolic resin	Cross-linkable polyurethane	Cross-linkable polyurethane	Cross-linkable polyurethane	
ctivation emperature	re [°C]	>120	>110	>75	>75	
pecial eatures		Temperature resistance, chemical resistance	Impact resistance, low bonding pressure	Impact resistance, wettability on fabrics	Impact resistance, chemical resistance	
10 μ	μт	● 58469				
20	μт	● 58477				
25	μт		● 58701 ○ 8701			
30	μт	● 58471 ● 8471		0 8711		
	μm	● 58470	• 58702 o 8702	● 58460 ○ 8710 ○ 8722	● 58662	
60	μт	● 8472				
	μт	● 58473 ● 8473				
100	Dμm	● 58474 ● 8474	● 58704 ○ 8704	● 58484 ○ 8714	● 58664	
125	5 μm	● 58475 ● 8475				
150	Dμm	● 58476 ● 8476	● 58706 ○ 8706	● 58486		
200	0 μm	● 58478 ● 8478	● 58708 ○ 8708	● 58488		
300	0 μm	3 0.00		● 58489		
	ference oduct	● 58474	● 58704	● 58484	● 58664	
	ference ostrate	SUS/SUS	AL/PC	PC/PC	AL/AL	
Pus [MF	sh-out Pa]	>5.5	>4.0	>5.5	>4.0	
	Pont xy/z]	>0.5	>3.5	>4.0	>1.0	
	liability*	••••	•••	•••	••••	
	emical	••••	••	••	•••	

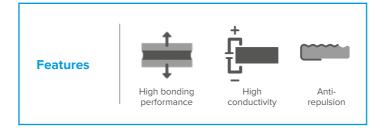
 $^{^{\}ast}$ Assessment is done only in relation to other products of this assortment

[●] Amber O Translucent O White ● Black

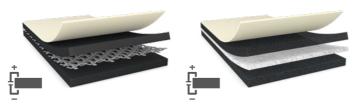


For applications requiring grounding

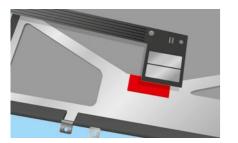
By offering a broad assortment of filled acrylic adhesive systems, with a balance between electrical conductivity and adhesive properties, we are able to provide the best solution for your requirements. Simply decide what is the most important for your application: bonding performance, conductivity, or a balance of both.



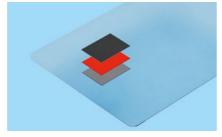
Our double-sided tapes are available with two different backings. The woven backing offers a higher tear resistance, very good dimensional stability, and better reworkability, while the nonwoven backing provides faster wetting, excellent conformability, and very good die cuttability.



Typical applications







FPC grounding

FPC on SUS

Component grounding

Assortment overview

		tesa® 6025x/6026x	tesa® 6036x	tesa® 6037x	tesa® 6038x	tesa® EC HAF 5845x
Des	ign	+	1		+	+
Col	or	Gray	Gray	Black	Gray	Black
Adh	nesive	Conductive acrylic	Conductive acrylic	Conductive acrylic	Conductive acrylic	Conductive structural adhesive
Bac	king	Woven, nonwoven	Woven	Woven, nonwoven	Woven, nonwoven	-
	cial ures	Balanced properties	High bonding strength, high conductivity	Best conductivity	Best bonding strength, repulsion resistance	Heat-activated structural bonding film, temperature and humidity resistance
	17 μm	o 60267				
	25 μm	o 60261				
	30 μm			● 60371		● 58451
	35 μm	o 60260				
S	50 μm	© 60262	● 60362	● 60372	6038160382	● 58452
CKIESS	55 μm	● 60251● 60252				
	70 μm	o 60253				
	100 μm	● 60254	o 60364	• 60374	● 60384 ● 60385	
	150 μm	o 60255				
	200 μm	● 60256				
	250 μm	● 60257	×			
	Reference product	● 60252 ● 60262	© 60362	● 60372	● 60381 ● 60382	● 58452
	Peel adhesion [N/cm; initial/ SUS ultimate]	5.4/8.3	7.0/8.0	4.3/5.6	8.0/10.0	n.a.
Product pe	Dynamic shear [N]	n.a.	n.a.	n.a.	n.a.	>7
	Contact resistance [mΩ.inch²]	0.05	0.01	0.01	0.06	0.05
	Surface resistance [mΩ.sq]	0.2	0.1	0.1	0.3	0.5
	Shielding effectiveness [-dB]	>50	>60	>50	>50	~40



For shielding and covering applications

Covering and shielding applications are broad and have different requirements for conductivity, adhesion, and design. Our single-sided ECT assortment meets the latest requirements for shielding and appearance.

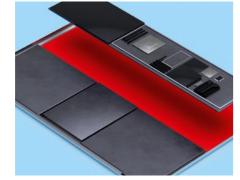




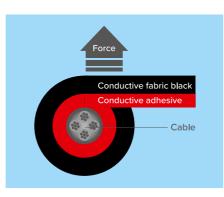


Typical applications





MLB shielding



Wire wrapping

Assortment overview

		tesa® 6023x	tesa® 6053x	tesa® 6031x	tesa® 6034x
Des	sign	į.			1
Col	lor	Matte black	Orange	Orange	Gray
Adl	hesive	Conductive acrylic	Conductive acrylic	Conductive acrylic	Conductive acrylic
Bad	cking	Fabric, copper	Copper	Copper	Fabric
	ecial tures	Modern, matte black design	Excellent bonding	Low-pressure activation, high conductivity	Low-pressure activation, high conductivity
	25 μm	● 60231			
	30 μm		• 60537	• 60317	o 60347
	35 μm	● 60232			
	45 μm	● 60238			
	50 μm		• 60538	• 60318	o 60348
	55 μm	● 60234			
	Reference product	● 60232	• 60537	• 60317	● 60347
	Peel adhesion [N/cm; SUS initial/ ultimate]	3.5/4.5	6.3/7.5	4.6/5.3	3.5/4.8
	Contact resistance [mΩ.inch²]	0.05	0.05	0.03	0.03
	Surface resistance [mΩ.sq]	0.2	0.2	0.2	0.2
	Shielding effective- ness [-dB]	>50	>70	>70	>60

● Matte black ● Gray ● Orange

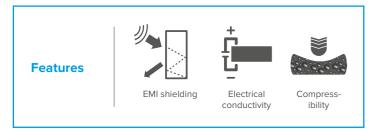
Didn't find what you were looking for? We have more options available in our portfolio, and by partnering with you we can create unique and specialized products that meet your individual demands. Simply write to us or contact your local representative: electronics@tesa.com





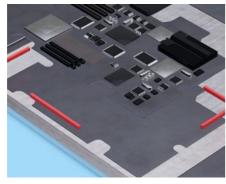
For conductive gap filling

Our single-sided electrically conductive foam tapes can be used for shielding, grounding, and filling gaps. They will provide either outstanding conformability and recovery properties or very high abrasion resistance, depending on the foam material chosen. All series in this assortment have very good shock-absorbing and cushioning properties.



Typical applications





FPC grounding

MLB grounding

Assortment overview

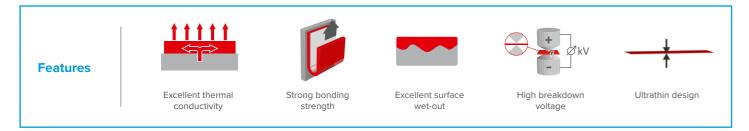
		tesa® 6021x	tesa® 6068x	tesa® 6024x
De	sign		+	
Со	lor	Gray	Gray	Gray
Ad	hesive	Conductive acrylic	Conductive acrylic	Conductive acrylic
Ba	cking	Soft foam	Ultrasoft foam	Gasket foam
	ecial itures	Excellent electrical conductivity	Excellent compressibility	Abrasion resistance
	200 μm	© 60213		
	300 μm	o 60214		● 60246
SS	500 μm		o 60685	© 60248
Thickness	700 μm		o 60687	o 60249
누	1,000 μm		o 60688	
	1,500 μm Φ 60217			
	2,000 μm	© 60218		
	Reference product	© 60214	● 60685	● 60248
	Peel adhesion [N/cm; SUS initial/ ultimate]	4.8/8.3	6.0/8.0	4.8/6.3
Product performance	Contact resistance [mΩ.inch²]	0.03	0.03	0.03
Product pe	Surface resistance [mΩ.sq]	0.2	0.2	0.2
	Shielding effective- ness [-dB]	>70	>60	>70
	Compression force at 50% [N/cm ²]	<50	<6	<55
	Recovery rate after 24h [%]	90	96	96

Gra



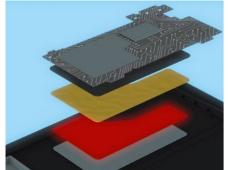
Keeping electronic devices cool

tesa® TMT 6074X provides superior thermal transfer performance with excellent bonding properties. It delivers very good surface wet-out on substrates due to the transfer tape design which helps to maximize the thermal transfer efficiency in electronic devices. The available thickness range starting from ultrathin 10 μ m ending at 100 μ m offers more flexibility in the device design.

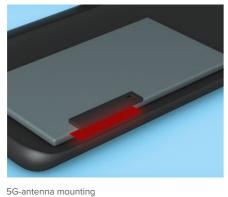


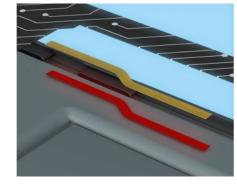
Typical applications

Vapor chamber mounting









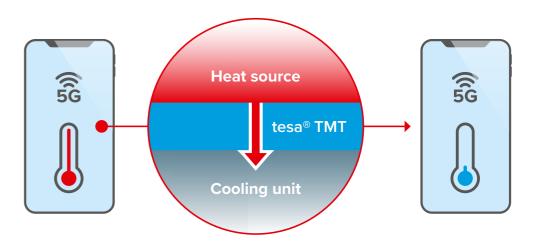
Heat pipe mounting

Assortment overview

	tesa® 6074x						
De	sign						
Со	lor	White					
Ba	cking	-					
	10 μm	o 60742					
ness	30 μm	o 60743					
Thickness	50 μm	0 60744					
	100 μm	O 60745					
	Reference product	o 60744					
Product performance	Peel adhesion [N/cm; SUS initial/ ultimate]	5.0					
Product p	Thermal conductivity [W/m x K]	1.0					
	Wetting [%]	84					
	Break- down voltage [kV]	2.9					

O White

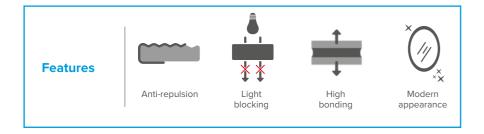
Cooling scenario



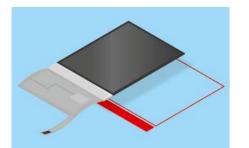


More functionality for electronic devices

Electronic components are evolving one generation after the other, just like our solutions for covering tape. Our portfolio consists of polyester and polyimide tapes.



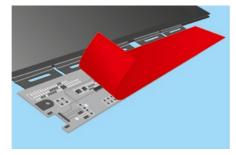
Typical applications



Light blocking in LCD backlight unit



Protection of magnetic sheet and coil in wireless charging



Insulation on PCB and FPC

Assortment overview

	tesa® 79xx	tesa® 71xx	tesa® 673xx	tesa® 663xx
Design				
Color	Matte black	Natural black	Matte black	Amber
Adhesive	Black tackified acrylic	Black tackified acrylic	Tackified acrylic	Tackified acrylic
Backing	PET	PET	PI	PI
Special eatures	Light blocking, anti-repulsion, dielectric insulation	Light blocking, anti-repulsion, high bonding	Light blocking, anti-repulsion, dielectric insulation, heat resistance	Anti-repulsion, dielectric insulation, heat resistance
5 μm	● 7905			
8 μm	● 7908			
10 μm	● 7910		● 67310	
20 μm	● 7920		● 67320	6 6320
30 μm 50 μm	● 7930		● 67330	6 6330
50 μm	● 7950	● 7250	● 67350	6 6350
60 μm		● 7160		
80 μm		● 7180		
100 μm		• 7100		
Reference product	● 7950	● 7250	● 67350	6 6350
Peel adhesion [N/cm; SUS initial/ ultimate]	4.0	4.2	3.5	4.0
initial/ ultimate] Light blocking [optical density] Insulation	5.7	>6	2.6	n.a.
Insulation [kV, dielectric breakdown voltage]	5.5	5.0	3.6	3.6
Anti-repulsion*	••••	Upon request	••••	•••

 $[\]ensuremath{^*}$ Assessment is done only in relation to other products of this assortment

● Amber ● Matte/Natural black

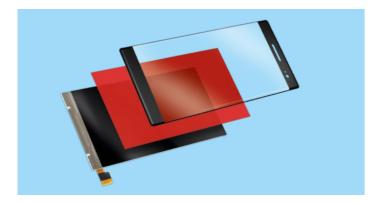
32 Functional solutions – Covering tapes 33



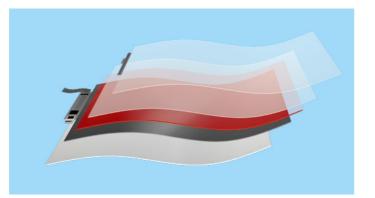
Optically clear design with special features

Our comprehensive assortment is designed to provide a solution for every display application. All our materials are produced in a clean room and fulfill optically clear requirements, while also being environmentally stable and compatible with other display layers.

Typical applications





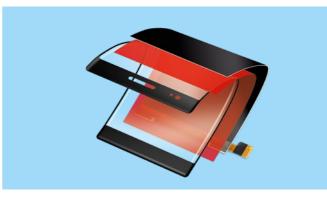


Touch panel lamination

New OCA developments

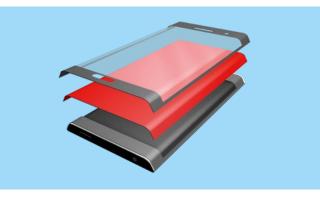
In addition to our active assortment, we are developing new materials to support handheld devices with **foldable and curved-edge displays**, as well as backside **cushioning tape**. Furthermore, we are developing new **OCA tapes for the automotive industry.**

Contact us to find out what's in our product development pipeline: electronics@tesa.com



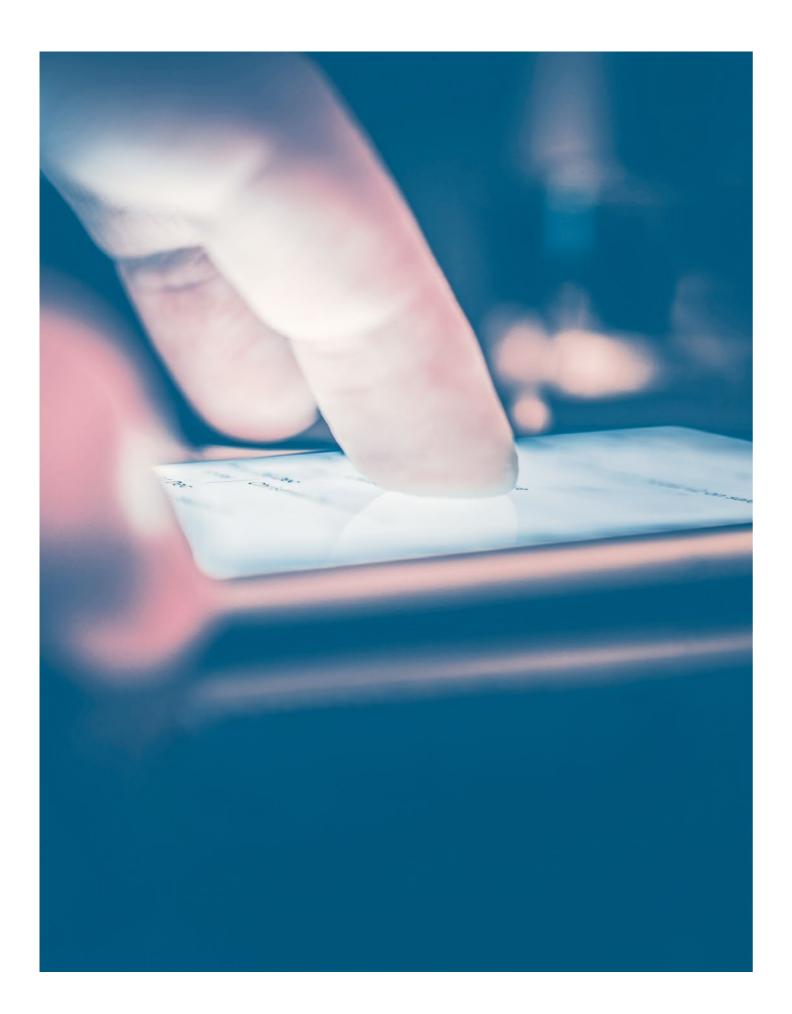
Flexible layers

Laminating flexible layers within a foldable or rollable display requires excellent peel adhesion and very good bending properties. For some special substrates like silver nanowire, an OCA tape with good compatibility is required. The first of such products will be available in May.



Curved display

Laminating a curved cover lens to a flexible OLED display requires low tack for easy lamination and good gap filling to cover ink steps. After UV curing, tapes need to show high bonding strength, resistance to repulsion forces, and very good reliability.



Assortment overview

		tesa® 698xx	tesa® 696xx	tesa® 694xx	tesa® 6156x	tesa® 6153x
Design Color Type Special features						
		Transparent UV-curable	Transparent UV-curable	Transparent PSA	Transparent PSA	Beige PSA
		25 μm				0 69401
50 μm		0 69802		0 69402	0 61563	o 61533
75 μm					O 61564	
100 μm		0 69804	0 69604	0 69404		
100 μm 125 μm			0 69605	0 69405		
150 μm		0 69806	0 69606			
175 μm			0 69607			
200 μm		0 69808	0 69608			
300 μm		0 69812	0 69612			
Reference product	e	O 69804	O 69604	O 69404	O 61563*	o 61533*
Peel	Glass	10.2	11.1	6.9	5.0	6.5
adhesion	PEI	7.6	7.9	4.8	3.3	6.0
ultimate]	PC	9.8	10.0	7.0	4.7	6.8
Trans- mission [%]	%]	>99	>99	>99	>99	n.a.
Haze [%]		<0.5	<0.5	<0.5	<0.5	n.a.
Refractive index	e	1.48	1.48	1.48	1.52	1.52
Gap filling	g [%]	30	25	10	<10	<10
Dielectric constant ¹		4.7	4.5	4.9	2.56	2.92
G' [kPa] ²		250	130	107	550	Upon request
WVTR ³ [g/m ² *day	y]	n.a.	n.a.	n.a.	0.9	0.45
Lag time ⁴	[h]	n.a.	n.a.	n.a.	25	10,000

^{*} Further thicknesses might be available upon request.

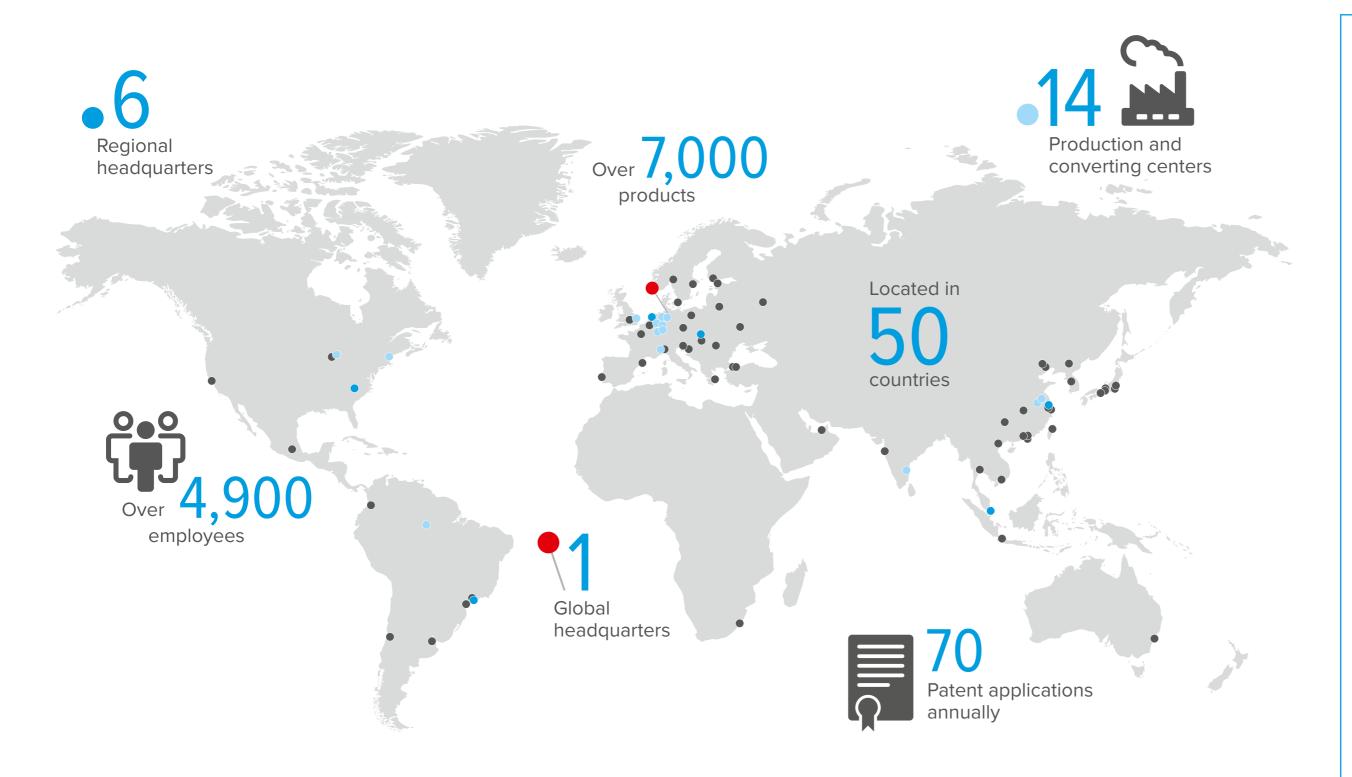
O Transparent O Beige

¹100 kHz

² 25°C, 1 Hz

^{3 38°}C, 90% rel. humidity, 1 mm 4 60°C, 90% rel. humidity, 6.5 mm gap 5 WVTR after all getter is used up

Global presence



tesa® products prove their impressive quality day in, day out in demanding conditions and are regularly subjected to strict controls. All technical information and data above mentioned are provided to the best of our knowledge on the basis of our practical experience. They shall be considered as average values and are not appropriate for a specification. Therefore tesa SE can make no warranties, express or implied, including, but not limited to any implied warranty of merchantability or fitness for a particular purpose. The user is responsible for determining whether the tesa® product is fit for a particular purpose and suitable for the user's method of application. If you are in any doubt, our technical support staff will be glad to support you.

Your local contacts

Hugo-Kirchberg-Straße 1 22848 Norderstedt | Germany

+49-40-888-990

electronics@tesa.com

USA

111 W Evelyn Ave Suite 215 Sunnyvale, CA 94086 | USA +1-408-461-8201

electronics@tesa.com

China

No. 1, 2500 Lane Xiu Pu Road 201315 Pudong | Shanghai, China

+86-21-6818-3110 electronics@tesa.com

City Air Tower, Office 1805 36 Teheran-ro 87-gil, Gangnam-gu Seoul 06164 | Korea

+82-2-34300-100 electronics@tesa.com

1-27-6 Shirokane, Shirokane Takanawa Station Bldg 8F Minato-ku 108-0072 | Tokyo, Japan

+81-3-6833-2300 electronics@tesa.com

Southeast Asia

9 North Buona Vista Drive 04-01 The Metropolis Tower 1 138588 | Singapore

+65-6697-9888 electronics@tesa.com

India

301, 3rd Floor, Lakhani Centrium, Plot No 27, Sec 15, CBD Belapur, Navi Mumbai – 400614, Maharashtra

+91-22-4741-9200 electronics@tesa.com

38 Global presence – Contacts Global presence - Contacts 39







Our company sees its orientation towards international quality, environmental, and occupational safety standards as a matter of course.

Please find more information regarding our international certifications under: www.tesa.com/certifications

tesa SE

Phone: +49-40-888-990 tesa.com/company/locations